

(1.27 mm) .050"

**FLE SERIES** 

# COST-EFFECTIVE RELIABLE SOCKET

channel. For full SI performance data

visit Samtec.com or contact

SIG@samtec.com

### **SPECIFICATIONS**

For complete specifications and recommended PCB layouts see www.samtec.com?FLE

Insulator Material: Black Liquid Crystal Polymer Contact Material:

hosphor Bronze

Au over 50 μ" (1.27 μm) Ni Current Rating:

2.9 A per pin

(2 pins powered)
Operating Temp Range:
-55 °C to +125 °C
Insertion Depth:

(1.83 mm) .072" to (4.37 mm) .172" or pass-through

Normal Force

100 grams (0.98 N) Max Cycles:

RoHS Compliant: Yes

## **PROCESSING**

Lead-Free Solderable:

SMT Lead Coplanarity:

(0.10 mm) .004" max

#### **RECOGNITIONS**

For complete scope of recognitions see www.samtec.com/quality

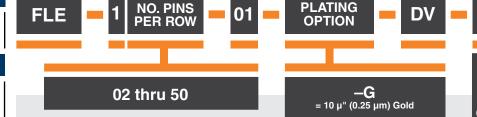


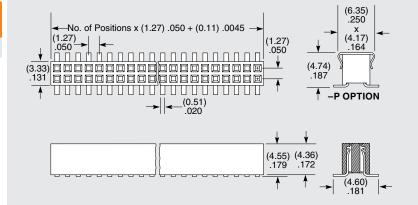
# **ALSO AVAILABLE** (MOQ Required)

Other platings

# Ideal for **Board Mates:** Tiger Beam™ pass-through contact applications **Cable Mates:** FFMD\*, FMTP EXTENDED LIFE PRODUCT \*Note: Standard FFMD callout will not mate with FLE, SFMC. Must use gold plated callouts. (See drawing on web.) Surface mount **HIGH-SPEED CHANNEL PERFORMANCE** Available with optional pick & place pads Rating based on Samtec reference (1.27 mm) .050"

micro pitch





## **OPTIONS**

= Alignment Pin

(Metal or plastic at Samtec discretion) (3 positions minimum)

= (4.25 mm) .167" DIA Polyimide film Pick & Place Pad (5 positions minimum)

-P

= Metal Pick & Place Pad (5 positions minimum)

> -TR = Tape & Reel

> > -FR

= Full Reel Tape & Reel Packaging (Must order maximum quantities per reel. Contact Samtec for parts per reel)

Some lengths, styles and options are non-standard, non-returnable.